V_{CC}

20UT

5

6 COMREF

2LINE

D PACKAGE

(TOP VIEW)

10UT

1LINE [] 3

GND [

COMSTRB 2

- Single 5-V Supply
- ±100-mV Sensitivity
- For Application as:
 - Single-Ended Line Receiver
 - Gated Oscillator
 - Level Comparator
- Adjustable Reference Voltage
- TTL Outputs
- TTL-Compatible Strobe
- Designed for Party-Line (Data-Bus) Applications
- Common Reference-Voltage Pin
- Common Strobe

description/ordering information

This device consists of a dual single-ended line receiver with TTL-compatible strobes and outputs. The reference voltage (switching threshold) is applied externally and can be adjusted from 1.5 V to 3.4 V, making it possible to optimize noise immunity for a given system design. Due to the low input current (less than 100 μ A), the device is suited ideally for party-line (data-bus) systems.

The SN74LS2323 has a common reference-voltage pin and a common strobe.

ORDERING INFORMATION

TA	PACI	KAGET	ORDERABLE PART NUMBER	TOP-SIDE MARKING
200 1 7000	0010 B	Tube	SN74LS2323D	1.00000
0°C to 70°C	SOIC – D	Tape and reel	SN74LS2323DR	LS2323

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (each receiver)

LINE INPUT	STROBE	OUTPUT
≤(V _{REF} - 100 mV)	L	Н
≥(V _{REF} + 100 mV)	Х	L
X	Н	L

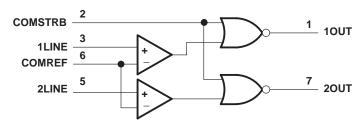
H = high level, L = low level, X = irrelevant



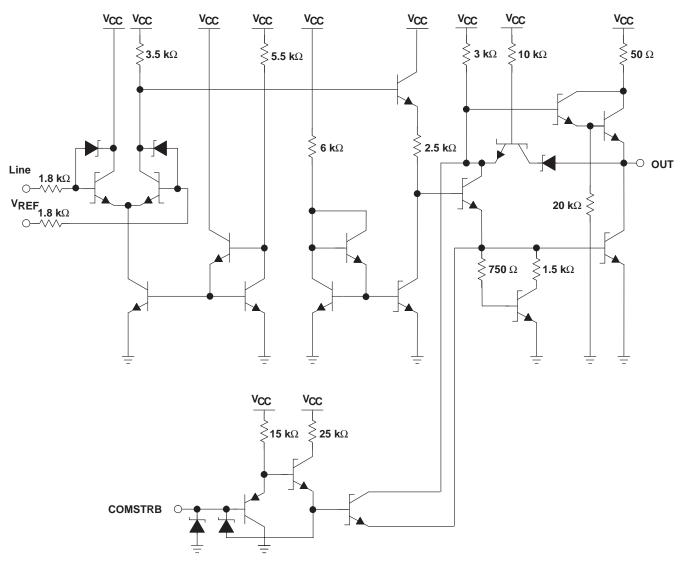
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logic diagram (positive logic)



schematic (each receiver)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	7 V
Reference input voltage, V _{REF}	5.5 V
Line input voltage range with respect to GND	
Line input voltage with respect to V _{REF}	$\dots \dots \pm 5 \ V$
Strobe input voltage, V _{I(S)}	$\dots \dots $
Package thermal impedance, θ _{JA} (see Note 2)	97°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T _{stq}	-65° C to 150° C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
V _{ref}	Reference input voltage	1.8		‡	V
V _{I(L)}	High-level line input voltage	0		V _{CC} – 1	V
V _{I(S)}	High-level strobe input voltage	0		7	V
TA	Operating free-air temperature range	0		70	°C

 $[\]frac{1}{1}$ Max = V_{CC}-1.5 V > V_{REF} < 3.4 V



NOTES: 1. Unless otherwise specified, voltage values are with respect to network ground terminal.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

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electrical characteristics over recommended operating free-air temperature range, V_{CC} = 5 V $\pm 10\%,\,V_{REF}$ = 1.5 V to 3.5 V (unless otherwise noted)

	PARAMETER	TEST CONDITIONS		MIN	MAX	UNIT
Marian	High level line input value	$V_{I(S)}$ = 0.8 V, I_{OL} = 12 mA, V_{REF} = 2.5 V, $V_{OL} \le$ 0.6 V	V _{CC} = 4.5 V	2.62	6	٧
V _{IH(L)}	High-level line input voltage	$\begin{aligned} & V_{I(S)} = 0.8 \text{ V}, \text{ I}_{OL} = 16 \text{ mA}, \text{ V}_{REF} = 3.4 \text{ V}, \\ & V_{OL} \leq 0.5 \text{ V} \end{aligned}$	V _{CC} = 5.5 V	3.5	7	V
,,		$V_{I(S)} = 0.8 \text{ V}, I_{OH} = -0.4 \text{ mA}, V_{REF} = 2.5 \text{ V}, V_{OH} \ge 2 \text{ V}$	V _{CC} = 4.5 V	-2	2.38	,,
V _{IL(L)}	Low-level line input voltage	$V_{I(S)} = 0.8 \text{ V}, I_{OH} = -0.4 \text{ mA}, V_{REF} = 3.4 \text{ V}, V_{OH} \ge 3.2 \text{ V}$	V _{CC} = 5.5 V	-2	3.3	V
V _{IH} (S)	High-level output control input voltage	$V_{I(L)} = 1.8 \text{ V}, V_{REF} = 2.5 \text{ V}, V_{O} \le 0.4 \text{ V}$	V _{CC} = 4.5 V	2		V
V _{IL} (S)	Low-level output control input voltage	$V_{I(L)} = 1.8 \text{ V}, V_{REF} = 2.5 \text{ V}, V_{O} \ge 2.4 \text{ V}$	V _{CC} = 4.5 V		0.8	V
			V _{CC} = 4.5 V	2		
Vон	High-level output voltage	$V_{I(L)} = 1.4 \text{ V}, V_{I(S)} = 0.8 \text{ V}, I_{OH} = -1 \text{ mA},$ $V_{RFF} = 2.5 \text{ V}$	V _C C = 5 V	2.7		V
		VKEF - 2.0 V	$V_{CC} = 5.5 \text{ V}$	2.7		
			$V_{CC} = 4.5 \text{ V},$ $I_{OL} = 16 \text{ mA}$		0.6	
VOL	Low-level output voltage	$V_{I(L)} = 3.8 \text{ V}, V_{I(S)} = 0.8 \text{ V}, V_{REF} = 2.5 \text{ V}$	V _{CC} = 5 V, I _{OL} = 24 mA		0.5	V
			V _{CC} = 5.5 V, I _{OL} = 24 mA		0.5	
	IPsh hard broad some of	V 00VV 05V	$V_{CC} = 5.5 \text{ V},$ $V_{I(S)} = 2.4 \text{ V}$		20	•
IH(S)	High-level input current	$V_{I(L)} = 3.8 \text{ V}, V_{REF} = 2.5 \text{ V}$	$V_{CC} = 5.5 \text{ V},$ $V_{I(S)} = 7 \text{ V}$		100	μΑ
		V 24VV 25V	V _{CC} = 5 V, V _{I(L)} = 5 V		100	μА
I _{IH(L)}	High-level input current	$V_{I(S)} = 2.4 \text{ V}, V_{REF} = 2.5 \text{ V}$	V _{CC} = 5 V, V _{I(L)} = 5.5 V		2	mA
I _{IH} (REF)	High-level input current	V _{I(S)} = 2.4 V, V _{REF} = 3.4 V	V _{CC} = 5.5 V, V _{I(L)} = 2.5 V		500	μА
I _{IL(S)}	Low-level input current	V _{I(L)} = 1.8 V, V _{REF} = 0.1 V	$V_{CC} = 5.5 \text{ V},$ $V_{I(S)} = 0.4 \text{ V}$		-400	μА
I _{IL(L)}	Low-level input current at Line input	V _{I(L)} = 0.1 V, V _{REF} = 1.8 V	$V_{CC} = 5.5 \text{ V},$ $V_{I(S)} = 0.4 \text{ V}$		-100	μΑ
IL(REF)	Low-level input current at REF pin	V _{I(L)} = 1.8 V, V _{REF} = 0.1 V	$V_{CC} = 5.5 \text{ V},$ $V_{I(S)} = 0.4 \text{ V}$		-100	μΑ
los	Short-circuit output current [‡]	V _{I(L)} = 1.8 V, V _{REF} = 2.8 V	V _{CC} = 5.5 V V _I (S) = 0.4 V	-30	-130	mA
ІССН	Supply current, output high	$V_{I(S)} = 0,$ $V_{CC} = 5.5 \text{ V}$ $V_{I(L)} = V_{REF} -$	100 mV		12	mA
ICCL	Supply current, output low	$V_{I(S)} = 0,$ $V_{CC} = 5.5 V$ $V_{I(L)} = V_{REF} +$	100 mV		16	mA

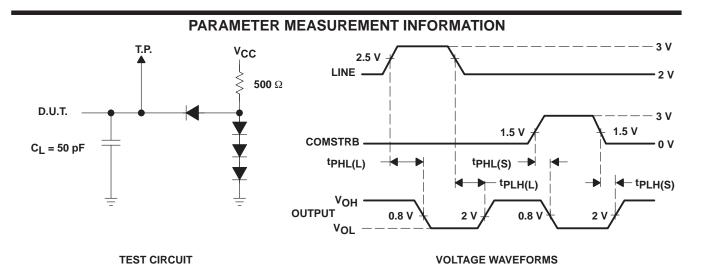
[†] Only one output should be shorted at a time, and duration of the short circuit should not exceed one second.



switching characteristics, V_{CC} = 5 V $\pm 10\%$, V_{REF} = 2.5 V, T_A = 0°C to 70°C

	PARAMETER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
tPLH(L)	Propagation delay time, low- to high-level output from LINE	C_L = 50 pF, R_L = 500 Ω , See Figure 1	10	25	35	ns
tPHL(L)	Propagation delay time, high- to low-level output from LINE	C_L = 50 pF, R_L = 500 Ω , See Figure 1	10	25	35	ns
tPLH(S)	Propagation delay time, low- to high-level output from COMSTRB	C_L = 50 pF, R_L = 500 Ω , See Figure 1		11	22	ns
tPHL(S)	Propagation delay time, high- to low-level output from COMSTRB	C_L = 50 pF, R_L = 500 Ω , See Figure 1		8	15	ns

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



NOTES: A. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, t_f and $t_f \leq$ 2 ns, and duty cycle = 50%.

- B. C_L includes probe and jig capacitance.
- C. All diodes are 1N914 (or equivalent).
- D. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



TAPE AND REEL INFORMATION





Α	0	Dimension designed to accommodate the component width
В	0	Dimension designed to accommodate the component length
		Dimension designed to accommodate the component thickness
٧	٧	Overall width of the carrier tape
ГР	1	Pitch between successive cavity centers

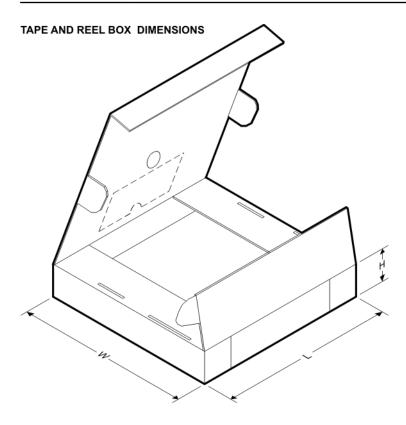
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS2323DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1



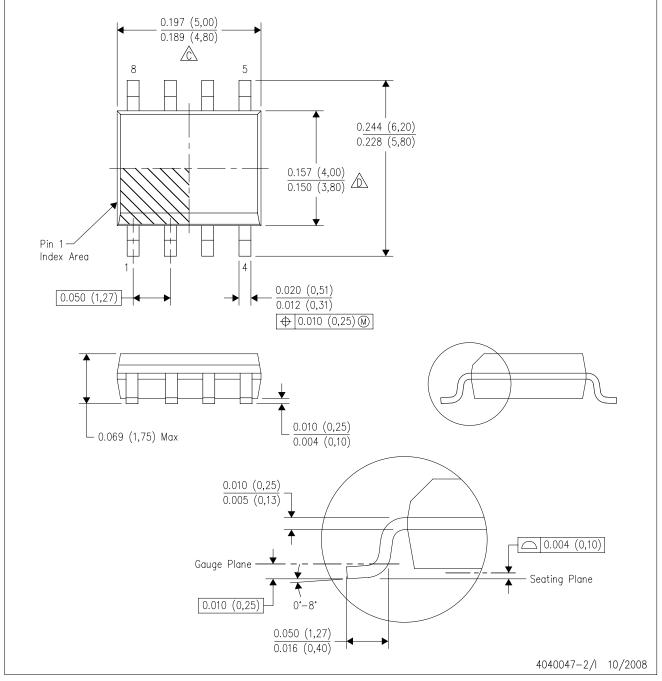


*All dimensions are nominal

ſ	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
I	SN74LS2323DR	SOIC	D	8	2500	340.5	338.1	20.6

D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AA.



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